



## STALLMAN & POLLOCK LLP 121 Spear Street, Suite 290

San Francisco, CA 94105

(415) 512-1312

Atty Docket No. CRDP-2700

In re Patent Application of: N. PARKER WILLIS ET AL.

Application No.: 09/128,304

Filed: August 3, 1998

For: A DYNAMICALLY ALTERABLE THREE-DIMENSIONAL GRAPHICAL MODEL OF A BODY

REGION

Commissioner for Patents Washington, D.C. 20231

Sir:

Transmittal herewith is an amendment in the above-identified application.

The fee has been calculated as shown below.

	CLAIMS		HIGHEST NO.	PRESENT	RATE	ADDITIONAL
	REMAINING		PREVIOUSLY	EXTRA		FEE
	AFTER		PAID FOR			
	AMENDMENT					
TOTAL	60	MINUS	60		x \$18 =	\$0
INDEP.	9	MINUS	9		x \$80 =	\$0
FIRST PRESENTATION OF MULTIPLE DEP CLAIMS					+ \$270	\$0
					TOTAL	\$0

Small Entity 50% Filing Fee Reduction (if applicable)

\$0

- If the entry in Col. 1 is less than the entry in Col. 2, write "0" in Col. 3
- If the "Highest Number Previously Paid For" IN THIS SPACE is less than 20, write "20" in this space.
- If the "Highest Number Previously Paid For" IN THIS SPACE is less than 3, write "3" in this space. The "Highest Number Previously Paid For" (Total or Independent is the highest number found from the equivalent box in Col. 1 of a prior amendment or the number of claims originally filed.)
- 1. No additional fee is required.

- 2. Applicant(s) hereby petition(s) for a one-month extension of time in which to file the present response and enclose(s) herewith the necessary fee to accompany this petition. A check-in the amount of \$55.00 is attached.
- amount of \$55.00 is attached.

  Please charge any additional fees, including any fees necessary for extensions of time or ereditations. 冈 3. overpayment to Deposit Account No. 50-1703, under Order No. A duplicate copy of this sheet is enclosed.

STALLMAN & POLLOCK LLP

(Reg. No. 37,326)

Attorneys for Applicant(s)

## **CERTIFICATE OF MAILING**

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, Washington, D.C. 20231, on July 30, 2001.

Dated: July 30, 2001